

## Certificate of Compliance

We certify that the product listed below is in compliance with the Directive 2002/95/EC of the European Parliament and of the Council on the restriction of the use of certain hazardous substances in electrical and electronics equipment. (27 January 2003, RoHS Directive)

The product model	Remarks
12 5nF±/ 20nnm	This product is Lead-containing. Lead in high melting temperature type solders (i.e. tin-lead solder alloys containing more than 85 % lead) which are exempted from the RoHS directive.

Company name:

**EPSON TOYOCOM CORPORATION** 

**Environment & Safety Promotion Department** 

**Company Address:** 

8548, Nakaminowa Minowamachi, Kamiina-gun, Nagano-ken ,Japan

Signature:

Toshiyuki Miyajima (General Manager)

**Issue Date:** 

Name(Title):

26-Sep-2008

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